



Product Change Notification: RMES-05KNAD022

Date:

08-Apr-2025

Product Category:

Clock and Timing - Oscillators

Notification Subject:

CCB 4891 Final Notice: Qualification of a new fabrication site (Microchip - Fab5) for Die # 2 of selected DSC12xx, DSA12xx and DSC15xx device families available in 4L & 6L VDFN and 4L VLGA packages.

Affected CPNs:

[RMES-05KNAD022_Affected_CPN_04082025.pdf](#)

[RMES-05KNAD022_Affected_CPN_04082025.csv](#)

PCN Status: Final Notification

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the files found in the Affected CPNs section.

Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change: Qualification of a new fabrication site (Microchip - Fab5) for Die # 2 of selected DSC12xx, DSA12xx and DSC15xx device families available in 4L & 6L VDFN and 4L VLGA packages.

Pre and Post Summary Changes:

		Pre Change	Post Change
Fabrication Supplier and Location	Die # 1	Taiwan Semiconductor Manufacturing – Fab 3 (TC03)	Taiwan Semiconductor Manufacturing – Fab 3 (TC03)
	Die # 2	Silex Microsystems (SM01)	Microchip Technology Colorado – Fab 5 (MCSO)
Wafer Diameter	Die # 1	8 inches	8 inches

	Die # 2	6inches	6 inches
Quality Certification for Die # 1		ISO9001/ ISO41001/ IATF16949	ISO9001/ ISO41001/ IATF16949
Quality Certification for Die # 2		ISO9001	ISO9001/ ISO41001/ IATF16949

Impacts to Datasheet: None

Change Impact: None

Reason for Change: To improve manufacturability and on-time delivery performance by qualifying a second fabrication source at Microchip Technology Colorado - Fab 5 site for Die # 2.

Change Implementation Status: In Progress

Estimated First Ship Date: 05 May 2025 (date code: 2519)

Note Below EFSD: Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Timetable Summary:

	May 2022					>	April 2025				May 2025				
Work Week	19	20	21	22	23		14	15	16	17	18	19	20	21	22
Initial PCN Issue Date	X														
Qual Report Availability								X							
Final PCN Issue Date								X							
Estimated Implementation Date												X			

Method to Identify Change: Traceability Code

Qualification Report: Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History: May 06, 2022: Issued initial notification.

April 8, 2025: Issued final notification. Updated the affected CPN list. Attached the Qualification Report. Provided estimated first ship date to be on May 5, 2025.

Note: The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable product.

Attachments:

[PCN_RMES-05KNAD022 Qual Report.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

Affected Catalog Part Numbers (CPN)

DSC1223NI1-200M0000T

DSC1223NI3-166M0000

DSC1223NI3-166M0000T

DSC1221NI3-50M00000

DSC1221NI3-50M00000T

DSC1213NL3-C0037

DSC1213NL3-C0037T

DSC1201NE3-51M10000

DSC1201NE3-51M10000T

DSC1221NA2-25M00000

DSC1223NA2-106M2500

DSC1221NA2-100M0000

DSC1221NA2-20M00000

DSC1221NA2-25M00000T

DSC1223NA2-106M2500T

DSC1221NA2-100M0000T

DSC1221NA2-20M00000T

DSC1201NI2-26M66496

DSC1201NI2-47M40437

DSC1201NI2-22M85568

DSC1201NI2-40M63232

DSC1201NI2-26M66496T

DSC1201NI2-47M40437T

DSC1201NI2-22M85568T

DSC1201NI2-40M63232T

DSC1203NI3-375M0000

DSC1203NI3-375M0000T

DSC1203NE1-64M00000

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DSC1203NE1-64M00000T

DSC1203NI3-3M900000

DSC1203NI3-3M900000T

DSC1223NI3-3M900000

DSC1223NI3-3M900000T

DSC1500AA3A-PROG

DSC1522AA3A-25M00000

DSC1525AI2A-75M00000

DSC1522AI2A-12M80000

DSC1505AI3A-125M0000

DSC1505AI3A-100M0000

DSC1505AI3A-66M66670

DSC1505AI3A-48M00000

DSC1505AI3A-32M00000

DSC1505AI3A-26M00000

DSC1505AI3A-24M00000

DSC1505AI3A-8M000000

DSC1505AI3A-4M000000

DSC1502AI3A-156M2500

DSC1502AI3A-125M0000

DSC1502AI3A-100M0000

DSC1502AI3A-66M66670

DSC1502AI3A-48M00000

DSC1502AI3A-32M00000

DSC1502AI3A-26M00000

DSC1502AI3A-24M00000

DSC1502AI3A-8M000000

DSC1223DA1-122M8800T

DSC1223DA1-3M840000

DSC1223DA1-3M840000T

DSC1224DL3-27M00000

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DSC1224DL3-27M00000T

DSC1224DE2-50M00000

DSC1224DE2-125M0000

DSC1224DE2-50M00000T

DSC1224DE2-125M0000T

DSC1253BE1-156M2500

DSC1253BL2-148M5000

DSC1253BL2-148M3500

DSC1253BL3-94M00000

DSC1253BE1-156M2500T

DSC1253BL2-148M5000T

DSC1253BL2-148M3500T

DSC1253BL3-94M00000T

DSC1201BA3-PROG

DSC1204BA2-125M0000

DSC1201BA3-48M00000

DSC1201BA3-40M00000

DSC1201BA3-10M00000

DSC1221BA3-8M000000

DSC1200BA3-PROG

DSC1223BI2-156M2500

DSC1223BI1-200M0000

DSC1223BI1-148M5000

DSC1203BI2-100M0000

DSC1223BI2-100M0000

DSC1221BI3-25M00000

DSC1203BI3-300M0000

DSC1201BI1-125M0000

DSC1224BI1-156M2500

DSC1223BI2-50M00000

DSC1223BI2-66M66660

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DSC1201BI3-26M04296

DSC1224BI2-100M0000

DSC1222BI1-51M00000

DSC1202BI2-125M0000

DSC1203BI2-200M0000

DSC1203BI2-125M0000

DSC1203BI2-270M0000

DSC1223BI1-155M5200

DSC1223BI3-26M00000

DSC1222BI1-125M0000

DSC1221BI1-40M00000

DSC1223BI3-25M00000

DSC1223BI1-100M0000

DSC1223BI1-106M2500

DSC1223BI3-87M35154

DSC1223BI3-135M0000

DSC1223BI2-167M7721

DSC1203BI3-125M0000

DSC1224BI1-400M0000

DSC1204BL3-122M8800

DSC1204BL3-100M0000

DSC1201BL3-11M05920

DSC1200BL3-PROG

DSC1203BE1-312M5000

DSC1203BE3-148M5000

DSC1203BE3-100M0000

DSC1202BE3-75M00000

DSC1224BL2-100M0000

DSC1221BL2-25M00000

DSC1201BE3-24M57600

DSC1201BE3-22M57920

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DSC1211BE3-C0031

DSC1204BL3-122M8800T

DSC1204BL3-100M0000T

DSC1201BL3-11M05920T

DSC1200BL3-PROGT

DSC1203BE1-312M5000T

DSC1203BE3-148M5000T

DSC1203BE3-100M0000T

DSC1202BE3-75M00000T

DSC1224BL2-100M0000T

DSC1221BL2-25M00000T

DSC1201BE3-24M57600T

DSC1201BE3-22M57920T

DSC1211BE3-C0031T

DSC1223BI2-156M2500T

DSC1223BI1-200M0000T

DSC1223BI1-148M5000T

DSC1203BI2-100M0000T

DSC1223BI2-100M0000T

DSC1221BI3-25M00000T

DSC1203BI3-300M0000T

DSC1201BI1-125M0000T

DSC1224BI1-156M2500T

DSC1223BI2-50M00000T

DSC1223BI2-66M66660T

DSC1201BI3-26M04296T

DSC1224BI2-100M0000T

DSC1222BI1-51M00000T

DSC1202BI2-125M0000T

DSC1203BI2-200M0000T

DSC1203BI2-125M0000T

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DSC1203BI2-270M0000T

DSC1223BI1-155M5200T

DSC1223BI3-26M00000T

DSC1222BI1-125M0000T

DSC1221BI1-40M00000T

DSC1223BI3-25M00000T

DSC1223BI1-100M0000T

DSC1223BI1-106M2500T

DSC1223BI3-87M35154T

DSC1223BI3-135M0000T

DSC1223BI2-167M7721T

DSC1203BI3-125M0000T

DSC1224BI1-400M0000T

DSC1201BA3-PROGT

DSC1204BA2-125M0000T

DSC1201BA3-48M00000T

DSC1201BA3-40M00000T

DSC1201BA3-10M00000T

DSC1221BA3-8M000000T

DSC1200BA3-PROGT

DSC1223BI2-125M0000

DSC1223BI2-125M0000T

DSC1201BA3-50M00000

DSC1201BA3-50M00000T

DSC1211BI3-C0024

DSC1211BI3-C0024T

DSC1201BA3-100M0000

DSC1201BA3-100M0000T

DSC1502AI3A-4M000000

DSC1522AI2A-125M0000

DSC1525AI2A-75M00000T

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DSC1522AI2A-12M80000T

DSC1505AI3A-125M0000T

DSC1505AI3A-100M0000T

DSC1505AI3A-66M66670T

DSC1505AI3A-48M00000T

DSC1505AI3A-32M00000T

DSC1505AI3A-26M00000T

DSC1505AI3A-24M00000T

DSC1505AI3A-8M000000T

DSC1505AI3A-4M000000T

DSC1502AI3A-156M2500T

DSC1502AI3A-125M0000T

DSC1502AI3A-100M0000T

DSC1502AI3A-66M66670T

DSC1502AI3A-48M00000T

DSC1502AI3A-32M00000T

DSC1502AI3A-26M00000T

DSC1502AI3A-24M00000T

DSC1502AI3A-8M000000T

DSC1502AI3A-4M000000T

DSC1522AI2A-125M0000T

DSC1500AA3A-PROGT

DSC1522AA3A-25M00000T

DSC1522AI1A-22M68000

DSC1522AI1A-22M68000T

DSC1500AA3A-PROGB

DSC1522AA3A-125M0000

DSC1522AA3A-125M0000T

DSC1525AA1A-125M0000

DSC1525AA1A-125M0000T

DSC1522AI1A-100M0000

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DSC1522AI1A-100M0000T

DSC1522AI2A-114M2850

DSC1522AI2A-25M00000

DSC1522AI1A-125M0000

DSC1522AL1A-125M0000

DSC1522AL1A-25M00000

DSC1522AE2A-25M00000

DSC1522AL1A-125M0000T

DSC1522AL1A-25M00000T

DSC1522AE2A-25M00000T

DSC1522AI2A-114M2850T

DSC1522AI2A-25M00000T

DSC1522AI1A-125M0000T

DSC1500MA3A-PROG

DSC1524MA2A-20M00000

DSC1525MA2A-50M00000

DSC1522MA1A-25M00000

DSC1525MA1A-25M00000

DSC1522MA1A-20M00000

DSC1525MA1A-100M0000

DSC1522MA3A-50M00000

DSC1525MA1A-30M00000

DSC1525MA1A-33M33300

DSC1525MA1A-63M00000

DSC1522MA1A-24M00000

DSC1522MA1A-33M33333

DSC1522MI2A-25M00000

DSC1522MI2A-19M20000

DSC1525MI2A-25M00000

DSC1502MI1A-4M096000

DSC1525MI2A-33M33333

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DSC1524MI3A-33M33333

DSC1501MI1A-125M0000

DSC1501MI2A-125M0000

DSC1502MI2A-125M0000

DSC1505ML3A-125M0000

DSC1522ML2A-52M08333

DSC1525ML1A-25M00000

DSC1522ML1A-100M0000

DSC1522ML1A-12M00000

DSC1522ML1A-16M00000

DSC1522ML1A-20M00000

DSC1522ML1A-27M00000

DSC1522ML1A-50M00000

DSC1505ML3A-125M0000T

DSC1522ML2A-52M08333T

DSC1525ML1A-25M00000T

DSC1522ML1A-100M0000T

DSC1522ML1A-12M00000T

DSC1522ML1A-16M00000T

DSC1522ML1A-20M00000T

DSC1522ML1A-27M00000T

DSC1522ML1A-50M00000T

DSC1522MI2A-25M00000T

DSC1522MI2A-19M20000T

DSC1525MI2A-25M00000T

DSC1502MI1A-4M096000T

DSC1525MI2A-33M33333T

DSC1524MI3A-33M33333T

DSC1501MI1A-125M0000T

DSC1501MI2A-125M0000T

DSC1502MI2A-125M0000T

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DSC1500MA3A-PROGT

DSC1524MA2A-20M00000T

DSC1525MA2A-50M00000T

DSC1522MA1A-25M00000T

DSC1525MA1A-25M00000T

DSC1522MA1A-20M00000T

DSC1525MA1A-100M0000T

DSC1522MA3A-50M00000T

DSC1525MA1A-30M00000T

DSC1525MA1A-33M33300T

DSC1525MA1A-63M00000T

DSC1522MA1A-24M00000T

DSC1522MA1A-33M33333T

DSC1522MA1A-50M00000

DSC1522MA1A-40M00000

DSC1525MA1A-24M00000

DSC1522MA1A-27M00000

DSC1525MA2A-24M00000

DSC1522MA2A-25M00000

DSC1522MA1A-42M85714

DSC1525ML1A-27M00000

DSC1525ML1A-27M00000T

DSC1522MA1A-50M00000T

DSC1522MA1A-40M00000T

DSC1525MA1A-24M00000T

DSC1522MA1A-27M00000T

DSC1525MA2A-24M00000T

DSC1522MA2A-25M00000T

DSC1522MA1A-42M85714T

DSC1522MI3A-25M00000

DSC1522MI3A-25M00000T

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DSC1500MA3A-PROGB

DSC1502MI3A-24M00000

DSC1502MI3A-25M00000

DSC1502MI3A-50M00000

DSC1505MI3A-24M00000

DSC1505MI3A-25M00000

DSC1505MI3A-50M00000

DSC1502MI3A-24M00000T

DSC1502MI3A-25M00000T

DSC1502MI3A-50M00000T

DSC1505MI3A-24M00000T

DSC1505MI3A-25M00000T

DSC1505MI3A-50M00000T

DSC1522ML2A-25M00000

DSC1522ML2A-25M00000T

DSC1522MI3A-50M0000

DSC1522MI3A-50M00000

DSC1522MI3A-50M0000T

DSC1522MI3A-50M00000T

DSC1525MA2A-19M20000

DSC1505MA2A-19M20000

DSC1525MA2A-19M20000T

DSC1505MA2A-19M20000T

DSC1502MI1A-80M00000

DSC1505MI1A-80M00000

DSC1502MI1A-80M00000T

DSC1505MI1A-80M00000T

DSC1522MA1A-125M0000

DSC1522MA1A-125M0000T

DSC1525MA1A-125M0000

DSC1525MA1A-125M0000T

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DSC1522ML2A-125M0000

DSC1522ML2A-125M0000T

DSC1525MA1A-5M000000

DSC1502MI2A-25M00000

DSC1525ML1A-125M0000

DSC1525ML1A-125M0000T

DSC1502MI2A-25M00000T

DSC1525MA1A-5M000000T

DSA1221NA3-125M0000VAO

DSA1200NA3-PROGVAO

DSA1201NA3-PROGVAO

DSA1201NA2-8M000000VAO

DSA1201NI2-32M00000VAO

DSA1221NI1-90M00000VAO

DSA1221NI2-33M33333VAO

DSA1223NI2-100M0000VAO

DSA1223NI3-200M0000VAO

DSA1223NI3-233M3333VAO

DSA1201NI2-20M48000VAO

DSA1201NI2-32M00000TVAO

DSA1221NI1-90M00000TVAO

DSA1221NI2-33M33333TVAO

DSA1223NI2-100M0000TVAO

DSA1223NI3-200M0000TVAO

DSA1223NI3-233M3333TVAO

DSA1201NI2-20M48000TVAO

DSA1221NA3-125M0000TVAO

DSA1200NA3-PROGTVAO

DSA1201NA3-PROGTVAO

DSA1201NA2-8M000000TVAO

DSA1222NI3-125M0000VAO

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DSA1223NI1-25M00000VAO
DSA1222NI3-125M0000TVAO
DSA1223NI1-25M00000TVAO
DSA1221NI2-16M32000VAO
DSA1221NI2-16M32000TVAO
DSA1222NI3-3M900000VAO
DSA1222NI3-3M900000TVAO
DSA1221DA1-16M66600VAO
DSA1223DA1-125M0000VAO
DSA1223DA1-100M0000VAO
DSA1200DA3-PROGVAO
DSA1201DA3-PROGVAO
DSA1221DI2-40M00000VAO
DSA1221DI3-50M00000VAO
DSA1203DL2-156M2500VAO
DSA1223DL1-100M0000VAO
DSA1223DL2-100M0000VAO
DSA1224DL2-100M0000VAO
DSA1204DL3-100M0000VAO
DSA1204DL2-156M2500VAO
DSA1222DL2-100M0000VAO
DSA1224DL3-400M0000VAO
DSA1224DL2-156M2500VAO
DSA1204DL2-100.0000VAO
DSA1203DL2-156M2500TVAO
DSA1223DL1-100M0000TVAO
DSA1223DL2-100M0000TVAO
DSA1224DL2-100M0000TVAO
DSA1204DL3-100M0000TVAO
DSA1204DL2-156M2500TVAO
DSA1222DL2-100M0000TVAO

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DSA1224DL3-400M0000TVAO

DSA1224DL2-156M2500TVAO

DSA1204DL2-100.0000TVAO

DSA1221DI2-40M00000TVAO

DSA1221DI3-50M00000TVAO

DSA1221DA1-16M66600TVAO

DSA1223DA1-125M0000TVAO

DSA1223DA1-100M0000TVAO

DSA1200DA3-PROGTVAO

DSA1201DA3-PROGTVAO

DSA1201DL2-125M0000VAO

DSA1201DL2-125M0000TVAO

DSA1223DI2-100M0000VAO

DSA1223DI2-100M0000TVAO

DSA1224DL1-100M0000VAO

DSA1224DL1-100M0000TVAO

DSA1221DL2-24M00000VAO

DSA1221DL2-24M00000TVAO

DSA1223DL2-126M2500VAO

DSA1223DL2-156M2500VAO

DSA1223DL2-126M2500TVAO

DSA1223DL2-156M2500TVAO

DSA1201DA2-127M8720VAO

DSA1201DA2-127M8720TVAO

DSA1201DI1-48M00000VAO

DSA1201DI1-48M00000TVAO

DSA1201DA3-3M999996VAO

DSA1201DA3-4M000000VAO

DSA1201DA3-3M999996TVAO

DSA1201DA3-4M000000TVAO

DSA1203DA3-100M0000VAO

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DSA1203DA3-125M0000VAO

DSA1203DA3-100M0000TVAO

DSA1203DA3-125M0000TVAO

DSA1200BA3-PROGVAO

DSA1201BA3-PROGVAO

DSA1221BI3-125M0000VAO

DSA1221BI1-40M00000VAO

DSA1221BI3-25M00000VAO

DSA1223BI1-100M0000VAO

DSA1223BI1-106M2500VAO

DSA1223BI3-25M00000VAO

DSA1223BI3-87M35154VAO

DSA1222BL3-156M2500VAO

DSA1222BL3-156M2500TVAO

DSA1221BI3-125M0000TVAO

DSA1221BI1-40M00000TVAO

DSA1221BI3-25M00000TVAO

DSA1223BI1-100M0000TVAO

DSA1223BI1-106M2500TVAO

DSA1223BI3-25M00000TVAO

DSA1223BI3-87M35154TVAO

DSA1200BA3-PROGTVAO

DSA1201BA3-PROGTVAO

DSA1221BL2-24M57600VAO

DSA1221BL2-24M57600TVAO

DSA1223BI1-125M0000VAO

DSA1223BI2-100M0000VAO

DSA1223BI1-125M0000TVAO

DSA1223BI2-100M0000TVAO

DSA1224BL2-156M2500VAO

DSA1224BL2-156M2500TVAO

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DSA1221CA2-125M0000VAO

DSA1203CA2-100M0000VAO

DSA1223CA1-200M0000VAO

DSA1201CA2-24M00000VAO

DSA1201CA2-27M00000VAO

DSA1200CA3-PROGVAO

DSA1201CA3-PROGVAO

DSA1223CI2-100M0000VAO

DSA1203CI3-100M0000VAO

DSA1203CI3-125M0000VAO

DSA1224CI3-350M0000VAO

DSA1204CI3-100M0000VAO

DSA1201CI2-125M0000VAO

DSA1201CI3-133M0000VAO

DSA1201CI3-80M00000VAO

DSA1221CI1-125M0000VAO

DSA1221CI2-25M00000VAO

DSA1221CI2-65M53600VAO

DSA1221CI3-25M00000VAO

DSA1223CI1-20M00000VAO

DSA1223CI1-66M66666VAO

DSA1223CI3-100M0000VAO

DSA1221CI3-33M33333VAO

DSA1221CI2-20M00000VAO

DSA1223CI2-40M00000VAO

DSA1223CI3-322M2656VAO

DSA1223CL2-156M2500VAO

DSA1223CL2-125M0000VAO

DSA1223CL1-100M0000VAO

DSA1224CL1-156M2500VAO

DSA1223CL3-100M0000VAO

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DSA1223CL3-125M0000VAO

DSA1223CL2-100M0000VAO

DSA1202CL2-156M2500VAO

DSA1223CL1-106M2500VAO

DSA1223CL1-63M00000VAO

DSA1204CL1-156M2500VAO

DSA1222CL1-156M2500VAO

DSA1222CL3-156M2500VAO

DSA1224CL1-161M1328VAO

DSA1224CL1-100M0000VAO

DSA1223CL1-125M0000VAO

DSA1223CL2-156M2500TVAO

DSA1223CL2-125M0000TVAO

DSA1223CL1-100M0000TVAO

DSA1224CL1-156M2500TVAO

DSA1223CL3-100M0000TVAO

DSA1223CL3-125M0000TVAO

DSA1223CL2-100M0000TVAO

DSA1202CL2-156M2500TVAO

DSA1223CL1-106M2500TVAO

DSA1223CL1-63M00000TVAO

DSA1204CL1-156M2500TVAO

DSA1222CL1-156M2500TVAO

DSA1222CL3-156M2500TVAO

DSA1224CL1-161M1328TVAO

DSA1224CL1-100M0000TVAO

DSA1223CL1-125M0000TVAO

DSA1223CI2-100M0000TVAO

DSA1203CI3-100M0000TVAO

DSA1203CI3-125M0000TVAO

DSA1224CI3-350M0000TVAO

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DSA1204CI3-100M0000TVAO

DSA1201CI2-125M0000TVAO

DSA1201CI3-133M0000TVAO

DSA1201CI3-80M00000TVAO

DSA1221CI1-125M0000TVAO

DSA1221CI2-25M00000TVAO

DSA1221CI2-65M53600TVAO

DSA1221CI3-25M00000TVAO

DSA1223CI1-20M00000TVAO

DSA1223CI1-66M66666TVAO

DSA1223CI3-100M0000TVAO

DSA1221CI3-33M33333TVAO

DSA1221CI2-20M00000TVAO

DSA1223CI2-40M00000TVAO

DSA1223CI3-322M2656TVAO

DSA1221CA2-125M0000TVAO

DSA1203CA2-100M0000TVAO

DSA1223CA1-200M0000TVAO

DSA1201CA2-24M00000TVAO

DSA1201CA2-27M00000TVAO

DSA1200CA3-PROGTVAO

DSA1201CA3-PROGTVAO

DSA1221CA2-25M00000VAO

DSA1223CA2-135M0000VAO

DSA1221CA2-25M00000TVAO

DSA1223CA2-135M0000TVAO

DSA1223CA2-25M00000VAO

DSA1223CA2-50M00000VAO

DSA1224CL2-100M0000VAO

DSA1224CL2-100M0000TVAO

DSA1223CA2-25M00000TVAO

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DSA1223CA2-50M00000TVAO

DSA1224CI3-100M0000VAO

DSA1224CI3-100M0000TVAO

DSA1203CL1-135M0000VAO

DSA1203CL1-135M0000TVAO

DSA1221CI3-133M0000VAO

DSA1221CI3-133M0000TVAO

DSA1201CA3-120M0000VAO

DSA1223CL3-120M0000VAO

DSA1222CL3-120M0000VAO

DSA1223CL3-120M0000TVAO

DSA1222CL3-120M0000TVAO

DSA1201CA3-120M0000TVAO

DSA1222CL2-156M2500VAO

DSA1222CL2-156M2500TVAO

DSA1201CL2-49M15200VAO

DSA1201CL2-49M15200TVAO

DSA1224CL2-156M2500VAO

DSA1224CL2-156M2500TVAO

DSA1203CL2-125M0000VAO

DSA1203CL2-125M0000TVAO

DSA1204CL2-156M2500VAO

DSA1204CL2-156M2500TVAO

DSA1223CI2-20M00000VAO

DSA1223CI2-20M00000TVAO

DSA1202CI3-433M9200VAO

DSA1202CI3-433M9200TVAO

DSA1223CA3-33M00000VAO

DSA1223CA3-140M0000VAO

DSA1223CA3-33M00000TVAO

DSA1223CA3-140M0000TVAO

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DSA1203CA1-300M0000VAO

DSA1203CA1-300M0000TVAO

DSA1224CI2-100M0000VAO

DSA1224CI2-100M0000TVAO

DSC1522JI1A-25M00000

DSC1502JA3A-156M2500

DSC1500JA3A-PROG

DSC1522JA2A-33M33333

DSC1522JA2A-50M00000

DSC1525JA2A-50M00000

DSC1525JI1A-25M00000

DSC1522JI2A-33M33333

DSC1522JI3A-50M00000

DSC1525JI3A-100M0000

DSC1525JI3A-50M00000

DSC1522JI3A-25M00000

DSC1525JI2A-24M00000

DSC1522JI2A-50M00000

DSC1523JI1A-4M000000

DSC1522JL3A-125M0000

DSC1522JE2A-20M00000

DSC1522JE1A-25M00000

DSC1522JL2A-24M00000

DSC1522JL2A-25M00000

DSC1522JL2A-27M00000

DSC1522JL2A-50M00000

DSC1525JL2A-24M00000

DSC1525JL2A-25M00000

DSC1525JL2A-27M00000

DSC1525JL2A-50M00000

DSC1522JL3A-125M0000T

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DSC1522JE2A-20M00000T

DSC1522JE1A-25M00000T

DSC1522JL2A-24M00000T

DSC1522JL2A-25M00000T

DSC1522JL2A-27M00000T

DSC1522JL2A-50M00000T

DSC1525JL2A-24M00000T

DSC1525JL2A-25M00000T

DSC1525JL2A-27M00000T

DSC1525JL2A-50M00000T

DSC1525JI1A-25M00000T

DSC1522JI2A-33M33333T

DSC1522JI3A-50M00000T

DSC1525JI3A-100M0000T

DSC1525JI3A-50M00000T

DSC1522JI3A-25M00000T

DSC1525JI2A-24M00000T

DSC1522JI2A-50M00000T

DSC1523JI1A-4M000000T

DSC1522JI1A-25M00000T

DSC1502JA3A-156M2500T

DSC1500JA3A-PROGT

DSC1522JA2A-33M33333T

DSC1522JA2A-50M00000T

DSC1525JA2A-50M00000T

DSC1524JA3A-25M00000

DSC1522JA1A-25M00000

DSC1522JA1A-125M0000

DSC1524JA3A-25M00000T

DSC1522JA1A-25M00000T

DSC1522JA1A-125M0000T

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DSC1500JA3A-PROGB

DSC1525JI1A-125M0000

DSC1525JI1A-100M0000

DSC1525JI1A-75M00000

DSC1525JI1A-125M0000T

DSC1525JI1A-100M0000T

DSC1525JI1A-75M00000T

DSC1502JI1A-25M00000

DSC1502JI1A-25M00000T

DSC1503JI2A-24M80600

DSC1503JI2A-24M80600T

DSC1525JI2A-40M00000

DSC1525JI2A-40M00000T

DSC1522JI3A-12M00000

DSC1522JI3A-12M00000T

DSC1525JA1A-125M0000

DSC1525JA1A-125M0000T

DSC1502JI3A-12M28800

DSC1502JI3A-12M28800T

DSC1502JI3A-24M00000

DSC1502JI3A-24M00000T

DSC1502JI3A-25M00000

DSC1502JI3A-50M00000

DSC1505JI3A-24M00000

DSC1505JI3A-25M00000

DSC1505JI3A-50M00000

DSC1502JI3A-25M00000T

DSC1502JI3A-50M00000T

DSC1505JI3A-24M00000T

DSC1505JI3A-25M00000T

DSC1505JI3A-50M00000T

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DSC1505JI1A-25M00000

DSC1505JI1A-25M00000T

DSC1522JA3A-26M00000

DSC1525JA1A-80M00000

DSC1522JA3A-26M00000T

DSC1525JA1A-80M00000T

DSC1504JA1A-25M00000

DSC1504JA1A-25M00000T

DSC1522JA2A-127M8720

DSC1522JA2A-127M8720T

DSC1522JI2A-25M00000

DSC1522JI2A-25M00000T

DSC1505JA2A-125M0000

DSC1505JA2A-125M0000T

DSC1203CI3-100M0000

DSC1201CA3-PROG

DSC1221CA3-25M00000

DSC1201CA3-20M00000

DSC1221CA2-25M00000

DSC1223CA2-156M2500

DSC1213CA3-C0026

DSC1203CA3-100M0000

DSC1203CA3-125M0000

DSC1213CA2-C0020

DSC1221CA3-24M00000

DSC1221CA3-33M33333

DSC1200CA3-PROG

DSC1223CA2-27M00000

DSC1203CA3-200M0000

DSC1203CI2-100M0000

DSC1222CI3-156M2500

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DSC1224CI2-100M0000

DSC1203CI3-133M3300

DSC1203CI3-133M3333

DSC1222CI2-125M0000

DSC1222CI2-156M2500

DSC1223CI2-156M0000

DSC1223CI2-156M2500

DSC1223CI2-180M0000

DSC1223CI2-133M3333

DSC1222CI2-155M5200

DSC1222CI2-25M00000

DSC1202CI3-106M2500

DSC1222CI2-212M5000

DSC1221CI2-25M00062

DSC1224CI2-38M40000

DSC1222CI1-156M2500

DSC1204CI2-100M0000

DSC1201CI2-28M63636

DSC1223CI1-100M0000

DSC1221CI3-24M57600

DSC1223CI3-125M0000

DSC1204CI2-148M5000

DSC1203CI2-148M5000

DSC1223CI3-148M5000

DSC1223CI2-100M0000

DSC1222CI2-156M2935

DSC1223CI3-429M5000

DSC1221CI3-148M5000

DSC1203CI3-200M0000

DSC1203CI3-125M0000

DSC1203CI3-106M2500

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DSC1211CI2-C0028

DSC1221CI1-32M00000

DSC1223CI3-26M00000

DSC1222CI3-164M4257

DSC1224CI3-350M0000

DSC1223CI3-100M0000

DSC1212CI3-C0029

DSC1214CI3-C0020

DSC1203CI2-400M0000

DSC1201CI3-133M0000

DSC1221CI2-65M53600

DSC1221CI3-25M00000

DSC1201CI3-80M00000

DSC1201CI2-125M0000

DSC1221CI1-125M0000

DSC1221CI2-25M00000

DSC1223CI1-20M00000

DSC1223CI1-66M66666

DSC1204CI3-100M0000

DSC1221CI3-8M000000

DSC1221CI3-57M14250

DSC1201CI2-50M00000

DSC1223CI2-27M00000

DSC1223CI2-148M5000

DSC1223CI1-50M00000

DSC1200CL3-PROG

DSC1223CE3-40M00000

DSC1223CE3-80M00000

DSC1223CL3-156M2500

DSC1202CE3-106M2500

DSC1221CL2-25M00000

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DSC1203CE2-75M00000

DSC1223CL1-156M2500

DSC1222CE2-125M0000

DSC1214CL3-C0020

DSC1213CL3-C0020

DSC1201CL1-75M00000

DSC1223CL1-100M0000

DSC1224CL1-100M0000

DSC1203CE2-167M7722

DSC1203CL3-130M0000

DSC1202CL3-130M0000

DSC1223CE2-125M0000

DSC1222CE2-155M5200

DSC1221CE3-33M33333

DSC1224CL2-156M2500

DSC1224CL2-100M0000

DSC1223CL2-50M00000

DSC1223CL2-100M0000

DSC1223CL2-125M0000

DSC1223CL2-156M2500

DSC1223CL2-312M5000

DSC1223CL2-200M0000

DSC1223CL2-148M5000

DSC1203CL3-160M0000

DSC1203CL3-165M0000

DSC1211CE1-C0034

DSC1200CL3-PROGT

DSC1223CE3-40M00000T

DSC1223CE3-80M00000T

DSC1223CL3-156M2500T

DSC1202CE3-106M2500T

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DSC1221CL2-25M00000T

DSC1203CE2-75M00000T

DSC1223CL1-156M2500T

DSC1222CE2-125M0000T

DSC1214CL3-C0020T

DSC1213CL3-C0020T

DSC1201CL1-75M00000T

DSC1223CL1-100M0000T

DSC1224CL1-100M0000T

DSC1203CE2-167M7722T

DSC1203CL3-130M0000T

DSC1202CL3-130M0000T

DSC1223CE2-125M0000T

DSC1222CE2-155M5200T

DSC1221CE3-33M33333T

DSC1224CL2-156M2500T

DSC1224CL2-100M0000T

DSC1223CL2-50M00000T

DSC1223CL2-100M0000T

DSC1223CL2-125M0000T

DSC1223CL2-156M2500T

DSC1223CL2-312M5000T

DSC1223CL2-200M0000T

DSC1223CL2-148M5000T

DSC1203CL3-160M0000T

DSC1203CL3-165M0000T

DSC1211CE1-C0034T

DSC1203CI2-100M0000T

DSC1203CI3-100M0000T

DSC1222CI3-156M2500T

DSC1224CI2-100M0000T

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DSC1203CI3-133M3300T

DSC1203CI3-133M3333T

DSC1222CI2-125M0000T

DSC1222CI2-156M2500T

DSC1223CI2-156M0000T

DSC1223CI2-156M2500T

DSC1223CI2-180M0000T

DSC1223CI2-133M3333T

DSC1222CI2-155M5200T

DSC1222CI2-25M00000T

DSC1202CI3-106M2500T

DSC1222CI2-212M5000T

DSC1221CI2-25M00062T

DSC1224CI2-38M40000T

DSC1222CI1-156M2500T

DSC1204CI2-100M0000T

DSC1201CI2-28M63636T

DSC1223CI1-100M0000T

DSC1221CI3-24M57600T

DSC1223CI3-125M0000T

DSC1204CI2-148M5000T

DSC1203CI2-148M5000T

DSC1223CI3-148M5000T

DSC1223CI2-100M0000T

DSC1222CI2-156M2935T

DSC1223CI3-429M5000T

DSC1221CI3-148M5000T

DSC1203CI3-200M0000T

DSC1203CI3-125M0000T

DSC1203CI3-106M2500T

DSC1211CI2-C0028T

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DSC1221CI1-32M00000T

DSC1223CI3-26M00000T

DSC1222CI3-164M4257T

DSC1224CI3-350M0000T

DSC1223CI3-100M0000T

DSC1212CI3-C0029T

DSC1214CI3-C0020T

DSC1203CI2-400M0000T

DSC1201CI3-133M0000T

DSC1221CI2-65M53600T

DSC1221CI3-25M00000T

DSC1201CI3-80M00000T

DSC1201CI2-125M0000T

DSC1221CI1-125M0000T

DSC1221CI2-25M00000T

DSC1223CI1-20M00000T

DSC1223CI1-66M66666T

DSC1204CI3-100M0000T

DSC1221CI3-8M000000T

DSC1221CI3-57M14250T

DSC1201CI2-50M00000T

DSC1223CI2-27M00000T

DSC1223CI2-148M5000T

DSC1223CI1-50M00000T

DSC1201CA3-PROGT

DSC1221CA3-25M00000T

DSC1201CA3-20M00000T

DSC1221CA2-25M00000T

DSC1223CA2-156M2500T

DSC1213CA3-C0026T

DSC1203CA3-100M0000T

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DSC1203CA3-125M0000T

DSC1213CA2-C0020T

DSC1221CA3-24M00000T

DSC1221CA3-33M33333T

DSC1200CA3-PROGT

DSC1223CA2-27M00000T

DSC1203CA3-200M0000T

DSC1223CI1-65M00000

DSC1223CI1-65M00000T

DSC1224CI3-156M2500

DSC1224CI3-156M2500T

DSC1201CA3-50M00000

DSC1201CA3-50M00000T

DSC1204CI1-100M0000

DSC1204CI1-161M1328

DSC1204CI1-100M0000T

DSC1204CI1-161M1328T

DSC1223CA1-333M0000

DSC1223CA1-222M0000

DSC1223CA1-111M0000

DSC1223CA1-333M0000T

DSC1223CA1-222M0000T

DSC1223CA1-111M0000T

DSC1211CI3-C0024

DSC1211CI3-C0024T

DSC1201CA3-100M0000

DSC1201CA3-100M0000T

DSC1204CI2-83M25000

DSC1204CI2-83M25000T

DSC1222CI1-125M0000

DSC1222CI1-125M0000T

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DSC1223CE1-322M2656

DSC1223CE1-322M2656T

DSC1223CI1-125M0000

DSC1223CI1-125M0000T

DSC1223CA3-125M0000

DSC1223CA3-125M0000T

DSC1204CI2-161M1328

DSC1204CI2-161M1328T

DSC1213CI3-C0020

DSC1213CI3-C0020T

DSC1203CI2-26M00000

DSC1203CI2-26M00000T

DSC1202CL3-50M00000

DSC1202CL3-50M00000T

DSC1223CI3-74M25000

DSC1223CI3-74M25000T

DSC1223CI3-156M2500

DSC1223CI3-156M2500T

DSC1224CE2-50M00000

DSC1224CE2-125M0000

DSC1224CE2-50M00000T

DSC1224CE2-125M0000T

DSC1252DI1-156M2500

DSC1241DI3-C0030

DSC1201DI3-32M00000T

DSC1221DI2-66M00000T

DSC1221DI2-25M00000T

DSC1203DI2-125M0000T

DSC1204DI3-156M2500T

DSC1223DI2-100M0000T

DSC1204DI2-100M0000T

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DSC1221DI3-50M00000T

DSC1221DI2-40M00000T

DSC1213DI2-C0033T

DSC1221DI2-100M0000T

DSC1201DI3-12M00000T

DSC1204DI2-400M0000T

DSC1201DI3-10M00000T

DSC1224DI2-400M0000T

DSC1224DI1-400M0000T

DSC1223DI3-100M0000T

DSC1201DA3-PROGT

DSC1221DA2-25M00000T

DSC1221DA3-25M00000T

DSC1201DA3-25M00000T

DSC1223DA2-156M2500T

DSC1223DA3-100M0000T

DSC1203DA3-333M3333T

DSC1221DA3-21M00000T

DSC1203DA3-83M33333T

DSC1211DA2-C0032T

DSC1200DA3-PROGT

DSC1223DI2-125M0000

DSC1223DI2-125M0000T

DSC1223DI1-156M2500

DSC1223DI1-156M2500T

DSC1222DL3-100M0000

DSC1222DL3-100M0000T

DSC1201DI3-49M15200

DSC1201DI3-45M15840

DSC1201DI3-49M15200T

DSC1201DI3-45M15840T

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DSC1213BL2-C0036

DSC1213BL2-C0036T

DSC1222BI2-156M2539

DSC1222BI2-156M2539T

DSC1213BA1-C0038

DSC1213BA1-C0038T

DSC1224BL2-156M2500

DSC1224BL2-156M2500T

DSC1203NI2-148M5000

DSC1221NA1-27M00000

DSC1201NA3-PROG

DSC1200NA3-PROG

DSC1203NA1-20M00000

DSC1211NA3-C0024

DSC1201NI2-129M6000

DSC1203NI1-100M0000

DSC1222NI2-156M2500

DSC1222NI2-150M0000

DSC1221NI2-125M0000

DSC1211NI3-C0018

DSC1224NI3-156M2500

DSC1213NI2-C0019

DSC1203NI2-148M3500

DSC1223NI1-100M0000

DSC1223NI1-135M0000

DSC1223NI1-106M2500

DSC1223NI1-148M5000

DSC1223NI1-125M0000

DSC1223NI1-156M0000

DSC1223NI1-156M2500

DSC1203NI3-148M3500

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DSC1222NI1-50M00000

DSC1203NI3-200M0000

DSC1203NI3-125M0000

DSC1212NI1-C0027

DSC1201NI2-81M36000

DSC1221NI1-33M00000

DSC1203NI2-100M0000

DSC1201NI1-24M57600

DSC1204NI1-100M0000

DSC1223NI2-250M0000

DSC1221NI2-33M33333

DSC1221NI1-90M00000

DSC1223NI2-100M0000

DSC1223NI3-200M0000

DSC1223NI3-233M3333

DSC1203NI2-94M95000

DSC1222NI3-25M00060

DSC1201NI3-125M0000

DSC1200NL3-PROG

DSC1202NE2-156M2600

DSC1204NL3-122M8800

DSC1204NL3-100M0000

DSC1221NE1-75M00000

DSC1204NL1-100M0000

DSC1201NE3-64M98000

DSC1202NE2-156M2617

DSC1201NE3-64M08000

DSC1211NE3-C0021

DSC1201NE3-24M57600

DSC1201NE3-20M97152

DSC1221NE3-48M00000

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DSC1203NE1-125M0000

DSC1223NE1-125M0000

DSC1221NL1-125M0000

DSC1201NE1-2M500000

DSC1202NE3-75M00000

DSC1222NL3-10M00000

DSC1203NE3-15M00000

DSC1223NE3-15M00000

DSC1203NE3-120M0000

DSC1252DI1-156M2500T

DSC1241DI3-C0030T

DSC1201DA3-PROG

DSC1221DA2-25M00000

DSC1221DA3-25M00000

DSC1201DA3-25M00000

DSC1223DA2-156M2500

DSC1223DA3-100M0000

DSC1203DA3-333M3333

DSC1221DA3-21M00000

DSC1203DA3-83M33333

DSC1211DA2-C0032

DSC1200DA3-PROG

DSC1202DI3-156M0000

DSC1203DI3-156M0000

DSC1223DI2-148M3516

DSC1223DI2-148M5000

DSC1223DI2-156M2500

DSC1203DI3-100M0000

DSC1223DI3-200M0000

DSC1223DI2-150M0000

DSC1224DI2-125M0000

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DSC1201DI3-50M00000

DSC1222DI2-156M2500

DSC1223DI2-212M5000

DSC1203DI3-156M2500

DSC1213DI2-C0020

DSC1223DI1-100M0000

DSC1202DI1-156M2500

DSC1223DI1-80M00000

DSC1223DI1-50M00000

DSC1224DI1-100M0000

DSC1204DI2-148M5000

DSC1203DI2-148M5000

DSC1211DI2-C0025

DSC1221DI3-148M5000

DSC1221DI1-21M11840

DSC1221DI1-25M00000

DSC1222DI2-121M1090

DSC1224DI3-100M0000

DSC1203DI2-270M0000

DSC1201DI3-32M00000

DSC1221DI2-66M00000

DSC1221DI2-25M00000

DSC1203DI2-125M0000

DSC1204DI3-156M2500

DSC1223DI2-100M0000

DSC1204DI2-100M0000

DSC1221DI3-50M00000

DSC1221DI2-40M00000

DSC1213DI2-C0033

DSC1221DI2-100M0000

DSC1201DI3-12M00000

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DSC1204DI2-400M0000

DSC1201DI3-10M00000

DSC1224DI2-400M0000

DSC1224DI1-400M0000

DSC1223DI3-100M0000

DSC1222DL1-156M2500

DSC1200DL3-PROG

DSC1201DE3-50M00000

DSC1203DL2-100M0000

DSC1224DL1-100M0000

DSC1201DE3-32M00000

DSC1201DE3-90M00000

DSC1202DL1-156M2500

DSC1222DE2-445M5000

DSC1211DE1-C0023

DSC1222DL3-156M2500

DSC1203DL2-125M0000

DSC1201DL3-125M0000

DSC1201DL3-50M00000

DSC1223DE3-148M5000

DSC1223DL2-200M0000

DSC1223DL2-100M0000

DSC1224DL2-100M0000

DSC1224DL3-156M2500

DSC1201DE3-20M00000

DSC1222DL1-156M2500T

DSC1200DL3-PROGT

DSC1201DE3-50M00000T

DSC1203DL2-100M0000T

DSC1224DL1-100M0000T

DSC1201DE3-32M00000T

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DSC1201DE3-90M00000T

DSC1202DL1-156M2500T

DSC1222DE2-445M5000T

DSC1211DE1-C0023T

DSC1222DL3-156M2500T

DSC1203DL2-125M0000T

DSC1201DL3-125M0000T

DSC1201DL3-50M00000T

DSC1223DE3-148M5000T

DSC1223DL2-200M0000T

DSC1223DL2-100M0000T

DSC1224DL2-100M0000T

DSC1224DL3-156M2500T

DSC1201DE3-20M00000T

DSC1202DI3-156M0000T

DSC1203DI3-156M0000T

DSC1223DI2-148M3516T

DSC1223DI2-148M5000T

DSC1223DI2-156M2500T

DSC1203DI3-100M0000T

DSC1223DI3-200M0000T

DSC1223DI2-150M0000T

DSC1224DI2-125M0000T

DSC1201DI3-50M00000T

DSC1222DI2-156M2500T

DSC1223DI2-212M5000T

DSC1203DI3-156M2500T

DSC1213DI2-C0020T

DSC1223DI1-100M0000T

DSC1202DI1-156M2500T

DSC1223DI1-80M00000T

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DSC1223DI1-50M00000T

DSC1224DI1-100M0000T

DSC1204DI2-148M5000T

DSC1203DI2-148M5000T

DSC1211DI2-C0025T

DSC1221DI3-148M5000T

DSC1221DI1-21M11840T

DSC1221DI1-25M00000T

DSC1222DI2-121M1090T

DSC1224DI3-100M0000T

DSC1203DI2-270M0000T

DSC1224NL3-100M0000

DSC1222NE1-100M0000

DSC1201NE2-75M00000

DSC1202NE2-156M2500

DSC1201NE2-30M37000

DSC1221NE3-38M00000

DSC1223NE2-100M0000

DSC1202NE1-52M50000

DSC1202NE1-46M87500

DSC1203NL1-208M1250

DSC1201NE2-24M00000

DSC1221NL3-114M2850

DSC1224NL2-100M0000

DSC1200NL3-PROGT

DSC1202NE2-156M2600T

DSC1204NL3-122M8800T

DSC1204NL3-100M0000T

DSC1221NE1-75M00000T

DSC1204NL1-100M0000T

DSC1201NE3-64M98000T

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DSC1202NE2-156M2617T

DSC1201NE3-64M08000T

DSC1201DI3-24M80600

DSC1201DI3-24M80600T

DSC1223DL1-156M2500

DSC1223DL1-156M2500T

DSC1222DI1-156M2500

DSC1222DI1-156M2500T

DSC1201DI3-12M28800

DSC1201DI3-12M28800T

DSC1204DI1-156M2500

DSC1204DI1-156M2500T

DSC1201DI3-25M00000

DSC1201DI3-25M00000T

DSC1224DI1-156M2500

DSC1224DI1-156M2500T

DSC1223DE1-124M8000

DSC1223DE1-124M8000T

DSC1213DA3-C0035

DSC1213DA3-C0035T

DSC1222DI3-27M00000

DSC1222DI3-27M00000T

DSC1201DI2-74M25000

DSC1221DI2-74M25000

DSC1201DI2-74M25000T

DSC1221DI2-74M25000T

DSC1201DI1-48M00000

DSC1201DI1-48M00000T

DSC1223DA2-100M0000

DSC1223DA2-100M0000T

DSC1223DA1-5M000000

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DSC1223DA1-100M0000
DSC1223DA1-122M8800
DSC1223DA1-5M000000T
DSC1223DA1-100M0000T
DSC1211NE3-C0021T
DSC1201NE3-24M57600T
DSC1201NE3-20M97152T
DSC1221NE3-48M00000T
DSC1203NE1-125M0000T
DSC1223NE1-125M0000T
DSC1221NL1-125M0000T
DSC1201NE1-2M500000T
DSC1202NE3-75M00000T
DSC1222NL3-10M00000T
DSC1203NE3-15M00000T
DSC1223NE3-15M00000T
DSC1203NE3-120M0000T
DSC1224NL3-100M0000T
DSC1222NE1-100M0000T
DSC1201NE2-75M00000T
DSC1202NE2-156M2500T
DSC1201NE2-30M37000T
DSC1221NE3-38M00000T
DSC1223NE2-100M0000T
DSC1202NE1-52M50000T
DSC1202NE1-46M87500T
DSC1203NL1-208M1250T
DSC1201NE2-24M00000T
DSC1221NL3-114M2850T
DSC1224NL2-100M0000T
DSC1203NI2-148M5000T

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DSC1201NI2-129M6000T

DSC1203NI1-100M0000T

DSC1222NI2-156M2500T

DSC1222NI2-150M0000T

DSC1221NI2-125M0000T

DSC1211NI3-C0018T

DSC1224NI3-156M2500T

DSC1213NI2-C0019T

DSC1203NI2-148M3500T

DSC1223NI1-100M0000T

DSC1223NI1-135M0000T

DSC1223NI1-106M2500T

DSC1223NI1-148M5000T

DSC1223NI1-125M0000T

DSC1223NI1-156M0000T

DSC1223NI1-156M2500T

DSC1203NI3-148M3500T

DSC1222NI1-50M00000T

DSC1203NI3-200M0000T

DSC1203NI3-125M0000T

DSC1212NI1-C0027T

DSC1201NI2-81M36000T

DSC1221NI1-33M00000T

DSC1203NI2-100M0000T

DSC1201NI1-24M57600T

DSC1204NI1-100M0000T

DSC1223NI2-250M0000T

DSC1221NI2-33M33333T

DSC1221NI1-90M00000T

DSC1223NI2-100M0000T

DSC1223NI3-200M0000T

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DSC1223NI3-233M3333T

DSC1203NI2-94M95000T

DSC1222NI3-25M00060T

DSC1201NI3-125M0000T

DSC1201NA3-PROGT

DSC1200NA3-PROGT

DSC1203NA1-20M00000T

DSC1211NA3-C0024T

DSC1203NA1-156M2500

DSC1203NA1-156M2500T

DSC1223NI1-200M0000